

Fuseholder Open Design, Holder for MSx 250, THT



250 V · 1.6 W/6.3 A (VDE) /6.3 A (UL/CSA)



Description

- Through hole mounting

Standards

- UL 4248-1
- CSA 22.2 no. 4248-1

Approvals

- VDE Certificate Number: 40041146
- UL File Number: E39328


References

Fuseholder to [MSF 250](#); [MST 250](#); [MSTU 250](#); [MSU 250](#); [MXT 250](#)

Weblinks


[pdf-datasheet](#), [html-datasheet](#), [General Product Information](#), [Approvals](#), [CE declaration of conformity](#), [RoHS](#), [CHINA-RoHS](#), [REACH](#), [e-Shop](#), [SCHURTER-Stock-Check](#), [Distributor-Stock-Check](#), [Detailed request for product](#)

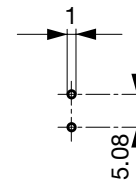
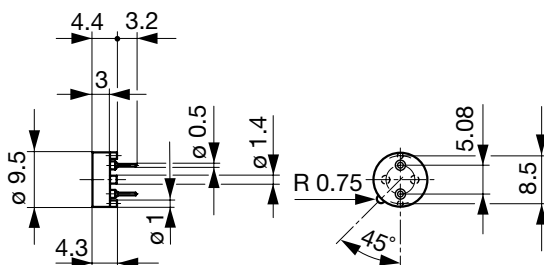
Technical Data

Fuse-Link	Microfuse 250 V
Mounting	PCB
Terminal	Solder THT
Rated Voltage	250 V (UL/CSA)
Rated current	6.3 A (VDE) / 6.3 A (UL/CSA)
Rated Power Acceptance IEC	1.6 W / 6.3 A @ Ta 23 °C Admissible power acceptance at higher ambient temperature see derating curves
Degree of Protection	IP 30 with installed fuse
Admissible Ambient Air Temp.	-40 °C to 85 °C
Climatic Category	40/085/21 acc. to IEC 60068-1
Material: Socket	Thermoplastic, UL 94V-0
Material: Terminals	Tin-Plated Copper Alloy
Unit Weight	0.37 g
Storage Conditions	0 °C to 60 °C, max. 70% r.h.
Product Marking	 Type

Soldering Methods	Wave Soldering Profile
Solderability	245 °C / 3 sec acc. to IEC 60068-2-20, Test Ta, method 1
Resistance to Soldering Heat	260 °C / 10 sec acc. to IEC 60068-2-20, Test Tb, method 1A
Contact Resistance	< 10 mΩ at 20 mV acc. to IEC 60127-6
Dielectric Strength	> 2.5 kV between Life parts (50 Hz; 1 min)
Insulation Resistance	> 10 MΩ between Life parts (500 VDC; 1 min)
Overvoltage Category	III acc. to IEC 60664-1
Pollution Degree	2 acc. to IEC 60664-1

Dimension

 7.6 mm



Variant 0031.7601

Drilling diagram

All Variants

Holder	Order Number
●	0031.7601

Most Popular.

Availability for all products can be searched real-time:
<http://www.schurter.com/en/Stock-Check/Stock-Check-SCHURTER>

Packaging Unit Plastic box (100 pcs.)
